

N-Ch MOSFET

General Description

The WSD40200DN56G use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics. This device is specially designed to get better ruggedness and suitable to use in

Features

Low RDS(on) & FOM Extremely low switching loss Excellent stability and uniformity or Invertors

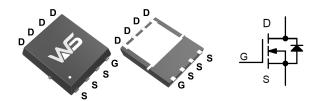
Product Summery

BVDSS	RDSON	ID
40V	1.15mΩ	180A

Applications

- Consumer electronic power supply
- Synchronous-rectification
- Synchronous-rectification applications

DFN5X6-8 Pin Configuration



Absolute Maximum Ratings at Tj=25℃ unless otherwise noted

Symbol	Parameter Rating		Units	
V_{DS}	Drain-Source Voltage 40		V	
V_{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹ 180			
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹ 125		А	
I _{DM}	Pulsed Drain Current ² 750		А	
EAS	Single Pulse Avalanche Energy ³ 420		mJ	
I _{AS}	Avalanche Current 70		Α	
P _D @T _C =25°C	Total Power Dissipation ⁴ 68		W	
T _{STG}	Storage Temperature Range -55 to 150		$^{\circ}$	
TJ	Operating Junction Temperature Range -55 to 150		$^{\circ}$	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient ¹		25	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		1.4	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	40			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA		0.043		V/℃
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V_{GS} =10V , I_D =30A		1.15	1.5	mΩ
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =20A		1.7	2.5	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	\/ =\/ =250\	1.1	1.8	2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-6.94		mV/℃
la co	Drain-Source Leakage Current	V_{DS} =32V , V_{GS} =0V , T_J =25 $^{\circ}\mathrm{C}$			1	uA
I _{DSS}		V _{DS} =32V , V _{GS} =0V , T _J =55℃			5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20 V$, V_{DS} = $0 V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		75		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.5		Ω
Q_g	Total Gate Charge (10V)	V _{DS} =20V , V _{GS} =4.5V , I _D =85A		127		
Q _{gs}	Gate-Source Charge			35		nC
Q_gd	Gate-Drain Charge			26		
T _{d(on)}	Turn-On Delay Time			23		
Tr	Rise Time	V _{DD} =20V , V _{GEN} =10V ,		8		200
T _{d(off)}	Turn-Off Delay Time	R_G =1.6 Ω , I_D =85A .		81		ns
T _f	Fall Time			27		
C _{iss}	Input Capacitance			8300		
C _{oss}	Output Capacitance	V _{DS} =20V , V _{GS} =0V , f=1MHz		1510		pF
C _{rss}	Reverse Transfer Capacitance			130		

Diode Characteristics

S	ymbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
	Is	Continuous Source Current	V _G =V _D =0V , Force Current			180	Α
	V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =30A , T _J =25℃			1.2	V

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2 .The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is VDD=20V,VGS=10V,L=0.5mH,IAS=70A
- 5 .The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.



Typical Characteristics

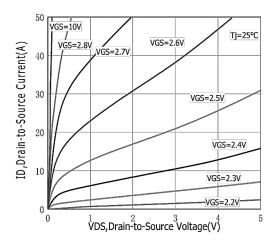


Figure1: Typical Output Characteristics

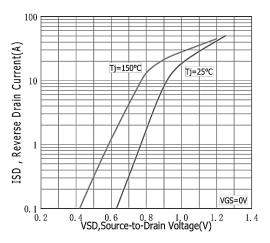


Figure 3: Typical Body Diode Transfer Characteristics

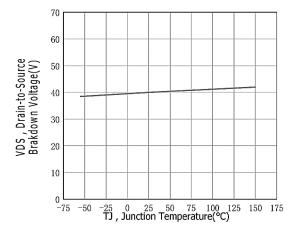


Figure 5: Typical Breakdown Voltage vs Junction Temperature

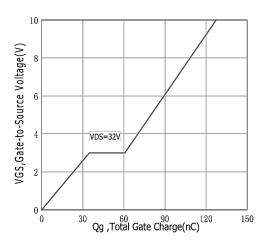


Figure 2: Typical GateCharge vs Gate to Source Voltage

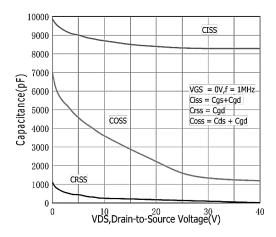


Figure 4: Typical Capacitance vs Drain to Source Voltage

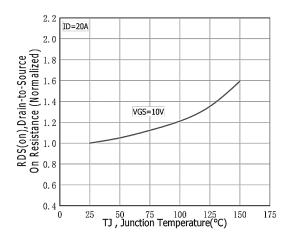


Figure 6: Typical Drain to Source on Resistance vs Junction Temperature



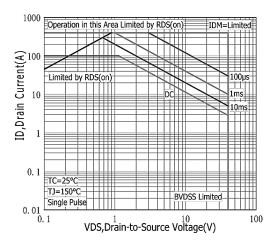


Figure 7: Maximum Forward Bias Safe Operating Area.

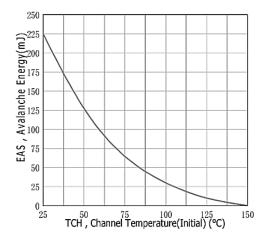


Figure 9: Maximum EAS vs Channel Temperature

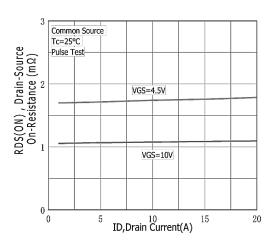


Figure 8: Typical Drain to Source ON Resistance vs Drain Current

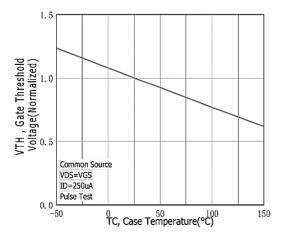


Figure 10: Typical Threshold Voltage vs Case Temperature

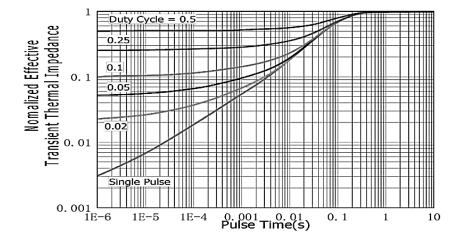


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Cas



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